

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOSV)

2SK2744

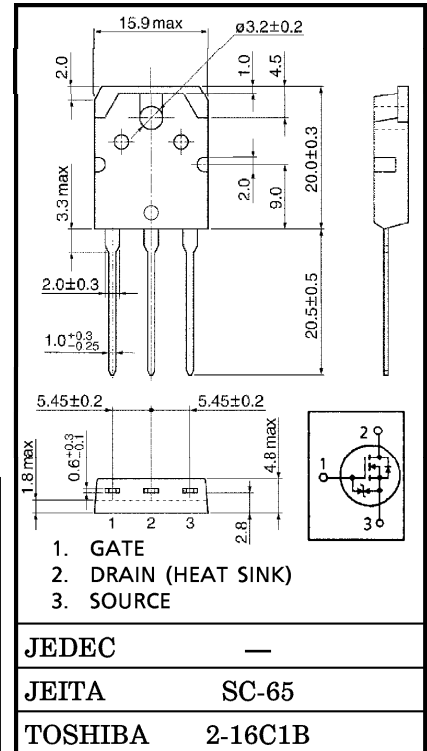
CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

Unit in mm

- 4 V Gate Drive
- Low Drain-Source ON Resistance : $R_{DS(ON)} = 15 \text{ m}\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 27 \text{ S}$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100 \mu\text{A}$ (Max.) ($V_{DS} = 50 \text{ V}$)
- Enhancement-Mode : $V_{th} = 1.5 \sim 3.5 \text{ V}$
($V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$)

MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	50	V
Drain-Gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	50	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	DC (Note 1)	I_D	45 A
	Pulse (Note 1)	I_{DP}	180 A
Drain Power Dissipation ($T_c = 25^\circ\text{C}$)	P_D	125	W
Single Pulse Avalanche Energy (Note 2)	E_{AS}	95	mJ
Avalanche Current	I_{AR}	45	A
Repetitive Avalanche Energy (Note 3)	E_{AR}	12.5	mJ
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	$-55 \sim 150$	$^\circ\text{C}$



Weight : 4.6 g (Typ.)

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.0	$^\circ\text{C/W}$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	50	$^\circ\text{C/W}$

- (Note 1) : Please use devices on condition that the channel temperature is below 150°C .
 (Note 2) : $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 58 \mu\text{H}$, $R_G = 25 \Omega$, $I_{AR} = 45 \text{ A}$
 (Note 3) : Repetitive rating ; Pulse Width Limited by maximum junction temperature.

**This transistor is an electrostatic sensitive device.
Please handle with caution.**

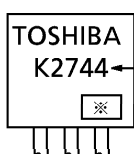
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		IGSS	VGS = ±16 V, VDS = 0 V	—	—	±10	μA
Drain Cut-off Current		IDSS	VDS = 50 V, VGS = 0 V	—	—	100	μA
Drain-Source Breakdown Voltage		V(BR)DSS	ID = 10 mA, VGS = 0 V	50	—	—	V
Gate Threshold Voltage		Vth	VDS = 10 V, ID = 1 mA	1.5	—	3.5	V
Drain-Source ON Resistance		RDS(ON)	VGS = 10 V, ID = 25 A	—	15	20	mΩ
Forward Transfer Admittance		Yfs	VDS = 10 V, ID = 25 A	15	27	—	S
Input Capacitance		Ciss	VDS = 10 V, VGS = 0 V, f = 1 MHz	—	2300	—	pF
Reverse Transfer Capacitance		Crss		—	420	—	
Output Capacitance		Coss		—	1200	—	
Switching Time	Rise Time	tr		—	30	—	ns
	Turn-on Time	ton		—	45	—	
	Fall Time	tf		—	80	—	
	Turn-off Time	toff		Duty ≤ 1%, tw = 10 μs	—	230	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Qg	VDD ≐ 40 V, VGS = 10 V, ID = 45 A	—	68	—	nC
Gate-Source Charge		Qgs		—	20	—	
Gate-Drain ("Miller") Charge		Qgd		—	48	—	

SOURCE-DRAIN RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current (Note 1)	IDR	—	—	—	45	A
Pulse Drain Reverse Current (Note 1)	IDRP	—	—	—	180	A
Forward Voltage (Diode)	VDSF	IDR = 45 A, VGS = 0V	—	—	-1.8	V
Reverse Recovery Time	trr	IDR = 455A, VGS = 0V	—	130	—	ns
Reverse Recovery Charge	Qrr	dIDR / dt = 50A / μs	—	0.3	—	nC

MARKING



※ Lot Number



Month (Starting from Alphabet A)

Year (Last Number of the Christian Era)

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